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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

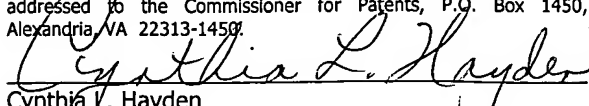
In re Applicant:	§	
Brian Taggart et al.	§	Art Unit: 2818
	§	
Serial No.: 10/807,830	§	Examiner: Calvin Lee
	§	
Filed: March 24, 2004	§	Docket: ITL.1119US
	§	P18791
For: Lower Profile Flexible Substrate	§	
Package for Electronic Components	§	Assignee: Intel Corporation
	§	

Mail Stop **Amendment**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO PAPER NO. 4

Sir:

In response to the office action mailed April 18, 2005, reconsideration is requested in view of the following remarks.

Date of Deposit: June 13, 2005
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Cynthia L. Hayden